



## E-tec Interconnect AG is the world leading Test socket manufacturer

Probe Pin (Pogo) Solderless compression Test Sockets type are available for any chip size and pitch and are attached with 2, 4 or 8 screws to the PCB. The assembly board ensures perfect coplanarity of the socket. Contact reliability is guaranteed with spring loaded gold plated contacts, which are pressed onto gold plated PCB pads. Probe Pin (Pogo) Solderless compression type sockets are available with all retention systems. We aim to solve your requirements. Please note, we will always request the chip data to ensure we offer a compatible socket.

	Contacts Specifications						
	Contact type code	0890	0891	0893	0892	0894	0898
ng	Application	Standard	High Frequency	Low Contact Resistance	High Frequency	Frequency	Frequency
	Mounting	Solderless	Solderless	Solderless	Solderless	Solderless	Solderless
	Bandwidth (Gilla@g1dB)	1 <b>3.4</b> GHz	36 GHz	7 GHz	31 GHz	14 GHz	31.7 GHz
	Contact resistance	<100 mOhm	100 mOhm	40 mOhm	90 mOhm	90 mOhm	25 mOhm
	Temperature range Chip contact tip shape Mathg cycles	Single Pointetip Concave tip	Single Point tip	Crown tip	Single Point tip	Single Point tip	Single Point tip
	PCB tip shape	Single Point tip	Single Point tip	Single Point tip	Spring	Spring	Spring
	Force	30 gr	33 gr	23 gr	20 gr	20 gr	25 gr
	Current rating	1.8 A	1 A	1 A	0.5 A	0.5 A	2.6 A
	Capacitance pF	<1 pF	0.47 pF	0.55 pF	0.37 pF	0.30 pF	0.60 pF
	Inductance nH	<2 nH	0.93 nH	1.08 nH	1.67 nH	1.66 nH	1.38 nH
	Impedance Ohms	40 Ω	38 Ω	39 Ω	73 Ω	78 Ω	44.8 Ω
	Temperature range	-55°C to +150°C	-40°C to +120°C	-50°C to +150°C	-55°C to +150°C	-55°C to +150°C	-55°C to +150°C
	Mating cycles	100 K	100 K	100 K	100 K	100 K	100 K

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